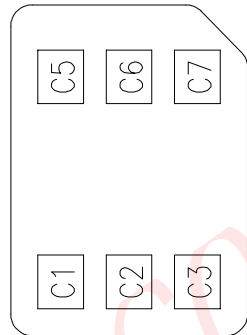
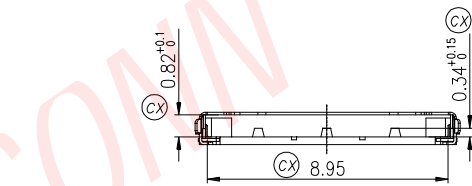
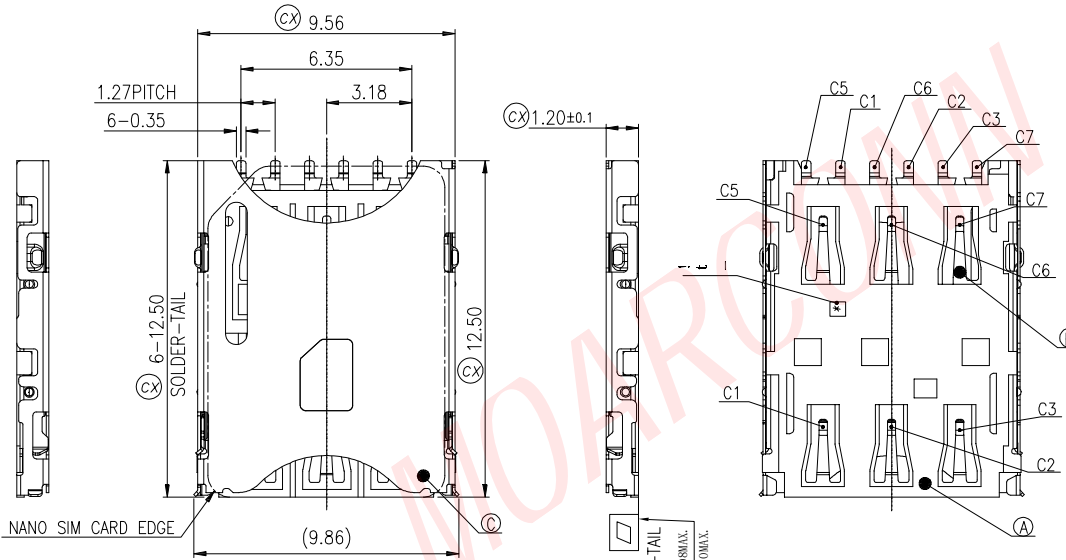
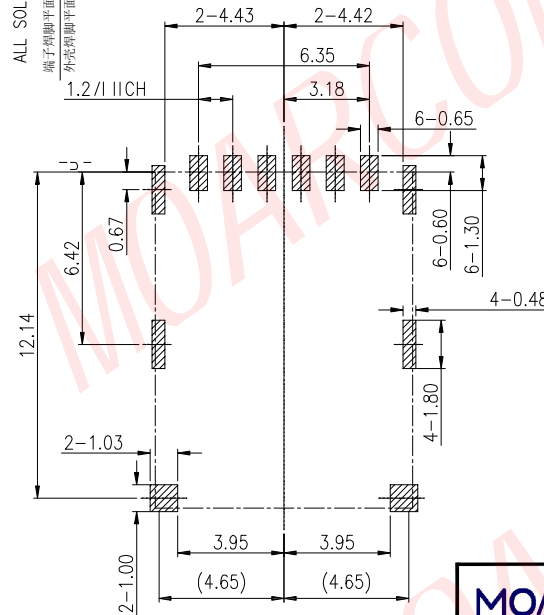


All materials, plating and process meet HF requirements.



NANO SIM CARD PAD



RECOMMENDED P.C.B. LAYOUT  
TOLERANCE (TOP VIEW) ±0.05mm

SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
  - CURRENT RATING: 1A.
  - DIELECTRIC WITHSTANDING VOLTAGE: 500V R.M.S MIN;
  - INSULATION RESISTANCE: 500MΩ MIN.
  - CONTACT RESISTANCE: 100mΩ MAX. (INITIAL)
- LIFE TEST: 1500 CYCLES.
- OTHER GENERAL SPEC. TO REFER "2SM2021-000111F SPEC".
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT: ⊙
- HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.
- PACKAGING: TAPE & REEL.
- ⊙ REPRESENT CRITICAL DIMENSIONS.
- ▽ REPRESENT CPK DIMENSIONS.

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
C	SHELL	1	STAINLESS STEEL, 0.10T	NICKEL PLATING OVER ALL
B	CONTACT	1	COPPER ALLOY, 0.10T	GOLD FLASH ON CONTACT AREA AND SOLDER AREA 50u" MIN NICKEL UNDER-PLATED
A	HOUSING	1	HIGH TEMP. THERMOPLASTIC UL 94V-0	BLACK

**MOARCONN**  
MORE CONNECTIONS SMART FUTURE

**DONG GUAN MOARCONN ELECTRONIC Co., Ltd.**

DIMENSIONS INIT:	mm
UNLESS OTHERWISE SPECIFIABLE	
DIMENSION	TOLERANCE
X.X: ±	0.20
X.XX: ±	0.10
X.XXX: ±	0.05
ANGULAR: ±	1°

PRODUCT NAME :	NANO SIM PUSH-PULL TYPE H1.20	DRAWING:	Alexander	DATE:	2021.10.13
PRODUCT NO. :	NS120-T1161-01	CHECK:	Alexander	DATE:	2021.10.13
DRAWING NO. :	D-NS120-T1161-01	APPROVED:	Aaron	DATE:	2021.10.13
SCALE:	1:1	DWG ID:	P D	REV.:	A
				PAGE:	1 OF 1

A	---	NEW RELEASE	FAJI	2021.10.13
REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				